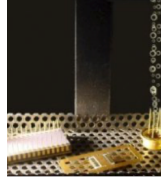


# Our Products

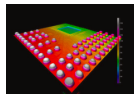
 **Syensqo Specialty Polymers**

Gross/Fine Leak Detection Fluid  
Thermal Shock Fluid  
Liquid Burn-In Test Fluid  
Lead Free & Vapor Phase Soldering Fluid  
Solef 6008 PVDF Semi-crystalline Thermoplastics



 **Nordson Yestech Automated Optical Inspection**

Yestech AOI for Wirebonds and SMT  
Matrix 2D & 3D AXI



 **Royce Instruments**

Bond Testers: Wire Pull/Bond Shear/Die Shear  
Die Sorters: Semi & Automated

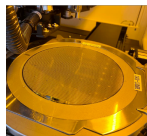


 **Suron Precision Technology**

Thermal and Heat Transfer Components  
Thermal and Getter Lids, Solder Preforms  
Carrier and Ceramic Substrates  
EMI/RFI Shielding Components

 **Camtek**

Sub-micron Defect Wafer Inspection System  
Wafer Inspection for Advanced Interconnect Packaging,  
Memory, CMOS Image Sensors, MEMS and RF, with  
Metrology



 **Micropoint PRO - Precision Bonding Tools**

Advanced Wedge Bonding Tools  
Die Collets & Vacuum Pick Up Tools  
Fluid Dispensing Tools  
Custom Micro-Components  
Manual Wire Bonders (Wedge, Ball, Dual)



 **RGT Inc.**

6", 8", 12" Wafer Frames  
55 Mounting Film Frames  
Plastic Film Frames



 **Separation Technologists (a ResinTech Company)**

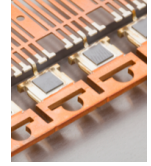
Total Solutions for Industrial Water Recycling  
Closed Loop DI Water, Water Purification, Waste Water  
Treatment



**Boschman Advanced Packing Technology**



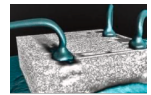
Packing Development  
Through Polymer Via Technology  
Assembly Services  
Film Assisted Transfer Molding  
Pressurized Ag Sintering Systems



**Nordson Dage X-Ray**



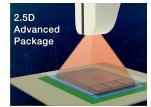
Dage Quadra 5 & 7 X-Ray Systems  
Dage XM8000 Fully Automated Metrology X-Ray



**Laserssel Corp.**



Laser Compression Bonding  
Laser Selective Reflow  
Laser Sintering Bonding



**Disco Hi-Tec America (Baja California)**



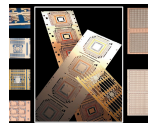
Wafer Grinding  
Saw & Laser Singulation  
Dicing Blades, Backgrind Tape, Backgrind Wheels  
KKM Wafer Processing Services



**ROKKO Systems & ROKKO Leadframes PTE LTD.**



Fully Integrated Package Saw Singulation Systems  
Stand-Alone Pick and Place Systems  
Custom Tooling & Conversion Kits



**KYOCERA International Inc.**



Electronic Mold Compound  
Die Attach Pastes: Conductive & Non-Conductive



**NGK Electronics Devices, Inc.**



Multilayer Ceramics  
Optical/High Speed Packages  
Pressed Ceramics  
Electronic Functional Components

